

Uwe Berger, Hella KGaA Ludger Kappius, Hella KGaA AEC Workshop Detroit, April 18th 2017

- Status AEC-Q102
- Content of AEC-Q102

- Benefit of AEC-Q102
 - Outlook



Status – Thank you!

Acknowledgment

Any document involving a complex technology brings together experience and skills from many sources. The Automotive Electronics Council would especially like to recognize the following significant contributors to the revision of this document: (in alphabetical order)







Hadi Mehrooz John Timms Mark A. Kelly Alfred Zhang Uwe Berger [Q1]

Uwe Berger [Q102 Team Leader] Ludger Kappius

Ludger Kappius Martin Rode Ken Kirby Continental Corporation Continental Corporation Delphi Corporation Delphi Corporation Hella

Hella Hella

Visteon Corporation





Bob Knoell Martin Gärtner Infineon

NXP Semiconductors Vishay



Olaf Wetzstein Serge Rudaz Hiroaki Kuroda Saori Mitsuhashi Automotive Lighting

Lumileds Nichia Nichia









VISHAY.



Status – AEC-Q102 ready to be published

AEC - Q102 - Rev -March 15, 2017

FAILURE MECHANISM BASED STRESS TEST QUALIFICATION FOR DISCRETE OPTOELECTRONIC SEMICONDUCTORS IN AUTOMOTIVE APPLICATIONS



- Dedicated for discrete optoelectronic semiconductors.
 - LED (visible & IR)
 - Laser
 - Photo Diodes
 - Photo Transistors
- Valid for exterior and interior automotive application



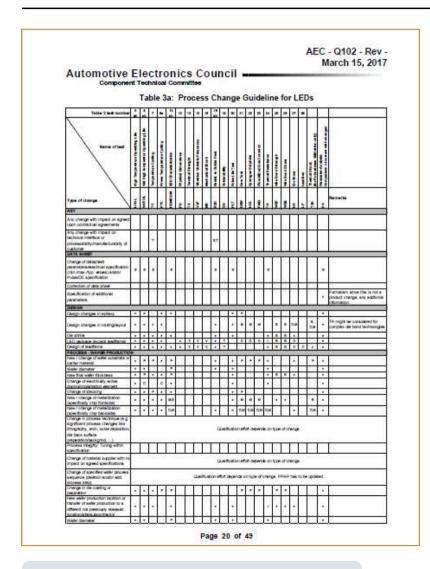
Content - Test Setup

| Te | st # AEC-Q102 | 1 | 2 | 3 | 4 | 5a | 5b | 5c | 6a | 6b | 6c | 7 | n.a. | n.a. | n.a. | 8a | 8b | 9 | 10a | 10b | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 | 24 | 25 | 26 | 27 | 28 |
|-------|---------------|------|----|----|----|-------|-------|------|--------|--------|-------|----|------|------|------|-----|-----|------|-----|------|-----|----|----|----|-----|-----|-----|-----|----|-----|-----|-----|-----|----|-----|-----|----|----|
| | | TEST | PC | EV | PV | HTOL1 | нтог2 | HTRB | WHTOL1 | WHTOL2 | H³TRB | TC | TSK | TCHT | WBI | PTC | IOL | LTOL | HBM | CDM | DPA | PD | TS | CA | VVF | SIM | HER | RSH | SD | PLT | DEW | H2S | FMG | TR | MBP | WBS | SO | WG |
| AE | C-Q101 (LED) | X | х | х | x | x | | | х | | X | х | | x | х | 2 | X | | х | х | х | х | x | х | x | х | х | x | X | | | | | x | X | х | х | x |
| IEC | 60810 | х | х | х | х | х | х | | х | х | | х | х | | | х | | | х | (MM) | х | х | | | х | х | | х | х | х | х | х | х | х | | | | |
| 102 | LED | х | х | х | x | x | х | | х | Х | | х | | | | х | | | х | х | х | х | х | | х | Х | | X | X | X | х | х | Х | X | Х | х | X | х |
| AEC-Q | Laser | х | х | х | х | х | х | | х | х | | х | | | | х | | х | х | х | х | х | х | х | х | х | х | х | х | х | х | х | х | х | х | х | х | х |
| AE | PD & PT | х | х | х | х | | | х | | | х | х | | | | | х | | х | х | х | х | х | | х | х | | х | х | | х | х | х | | х | х | х | х |

- Basis: AEC-Q101 rev. D
- Closer look to the test board assembly
- Detailed definition of failure criteria
- Enhanced criteria for pre- and post-stress tests to detect latent failures
 - Test not only at room but simple light / no light also at high & low temperature
 - Alternative: failure detection during stress test
- Documents for communication (CDCQ; qualification plan, test report)



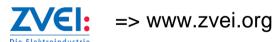
Content – Process Change Guideline



- Process Change Guideline for
 - LED
 - Laser
 - Photo Diodes
 - Photo Transistors



Based on ZVEI DeQuMa





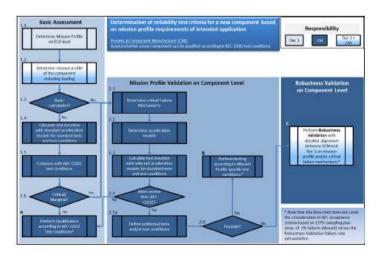
Content - Robustness Validation

Robustness Validation approach for LEDs

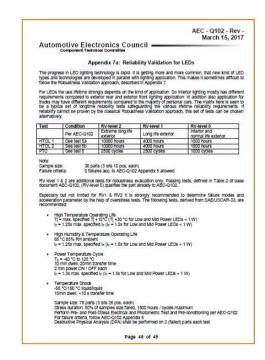
Acceleration models for

- Operation
- Thermomechanical
- Humidity

(see AEC-Q100/101)



Additional alternative





Content - Robustness Validation: RV Level

Appendix 7a: Reliability Validation for LEDs

The progress in LED lighting technology is rapid. It is getting more and more common, that new kind of LED types and technologies are developed in parallel with lighting application. This makes it sometimes difficult to follow the Robustness Validation approach, described in Appendix 7.

For LEDs the use lifetime strongly depends on the kind of application. So interior lighting mostly has different requirements compared to exterior rear and exterior front lighting application. In addition also application for trucks may have different requirements compared to the majority of personal cars. The matrix here is seen to be a typical set of longtime reliability tests safeguarding the various lifetime reliability requirements. If reliability cannot be proven by the classical Robustness Validation approach, this set of tests can be chosen alternatively.

| Test | Condition | RV-level 2 | RV-level 1 | RV-level 0 | | | | |
|--------|--------------|-------------------|--------------------|----------------------|--|--|--|--|
| | Per AEC-Q102 | Extreme long life | Long life exterior | Interior and | | | | |
| | PELACO-Q102 | exterior | Long life exterior | normal life exterior | | | | |
| HTOL 1 | See test 5a | 10000 hours | 4000 hours | 1000 hours | | | | |
| HTOL 2 | See test 5b | 10000 hours | 4000 hours | 1000 hours | | | | |
| PTC | See test 8 | 2500 cycles | 2500 cycles | 1000 cycles | | | | |

Note:

Sample size: 30 parts (3 lots 10 pcs. each)

Failure criteria: 0 failures acc. to AEC-Q102 Appendix 5 allowed



RV level 1 & 2 are additional tests for robustness evaluation only. Passing tests, defined in Table 2 of base document AEC-Q102, (RV-level 0) qualifies the part already to AEC-Q102.



Content - Robustness Validation: USCAR-33

Especially but not limited for RV1 & RV2 it is strongly recommended to determine failure modes and acceleration parameter by the help of overstress tests. The following tests, derived from SAE/USCAR-33, are recommended:



- High Temperature Operating Life
 Tj = max. specified Tj +15 °C (Tj +30 °C for Low and Mid Power LEDs < 1 W)
 I_E = 1.25x max. specified I_E (I_E = 1.5x for Low and Mid Power LEDs < 1 W)
- High Humidity & Temperature Operating Life
 85 °C 85% RH ambient
 I_F = 1.25x max. specified I_F (I_F = 1.5x for Low and Mid Power LEDs < 1 W)
- Power Temperature Cycle
 T_S = -40 °C to 125 °C
 10 min dwell, 20min transfer time
 2 min power ON / OFF each
 I_F = 1.3x max. specified I_F (I_F = 1.5x for Low and Mid Power LEDs < 1 W)
- Temperature Shock
 -55 ℃/150 ℃ liquid/liquid
 15min dwell, <10 s transfer time

Sample size: 78 parts (3 lots 26 pcs. each)

Stress duration: 50% of samples size failed, 1500 hours / cycles maximum

Perform Pre- and Post-Stress Electrical and Photometric Test and Pre-conditioning per AEC-Q102

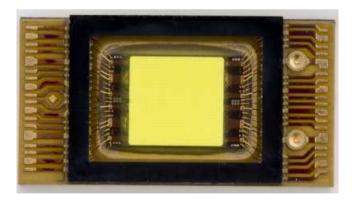
For failure criteria, follow AEC-Q102 Appendix 5

Destructive Physical Analysis (DPA) shall be performed on 2 (failed) parts each test



Benefit of AEC-Q102

- Acceptance of AEC qualification norms
- Knowledge of 60+ companies
- Focus on automotive needs
- Covering all automotive application
- Homogenity of requirements for all electronic components
- Ready for new technologies in automotive lighting



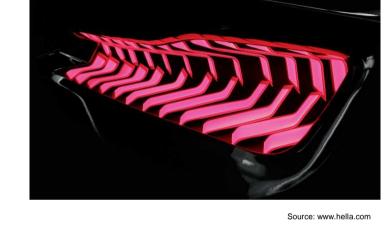
Source: www.hella.com

| Component | AEC-Q100 AEC-Q102 AEC-Q |
|-----------|-------------------------------|
| Modul | AEC-Q104 |



Outlook – Further Fields of Interest

- OLED
- Displays





Source: www.bhtc.com

- Relationship AEC / IEC
- Alignement of photometric testing method
- AEC general: soldering tests, CDM
- Zero Defect (see AEC-Q004 Draft)
- Combination tests



